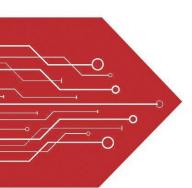
MSKSEMI















ESD

TVS

TSS

MOV

GDT

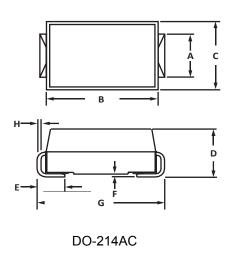
PLED

Broduct data speet



SURGE RATINGS

PART NUMBER	V P P 10x700us (V)	I P P 5x310us (A)	
P0080TA-MS	2KV	50	



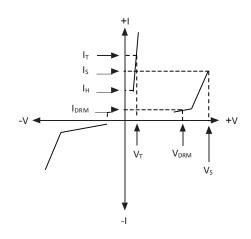
PART NUMBER AND ELEC TRICAL PARAMETER @ T=25°C RH = 45%-75%

TYPE	VDRM(V)	IDRM(uA)	Vs (v)	Is(ma)	Vr (v)	It(a)	Ih(ma)	CJ
P0080TA-MS	6	5	25	800	4	2.2	40	25

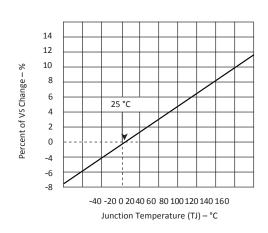
- **X** Vs is measured at 100KV/S
- **X** Off-state capacitance is measured in VDC=2V, VRMS=1V,F=1MHz

THERMAL CONSIDERATIONS

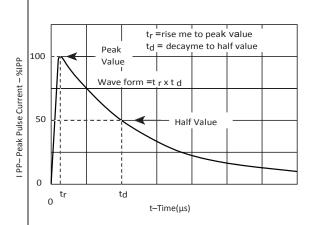
Symbol	Parameter	Value	Unit
T _J	Operaing Junc on Temperature	-55 to +1 25	C
T _S	Storage Temperature Range	-55 to +150	င
R _{0J A}	Juncton to Ambient on printed circuit	120	°C/W

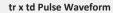


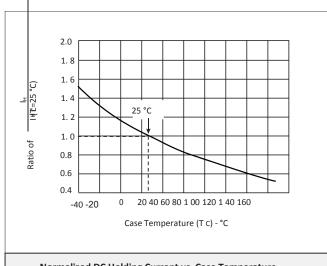
V-I Characteristics



Normalized V_S Change vs. Junction Temperature



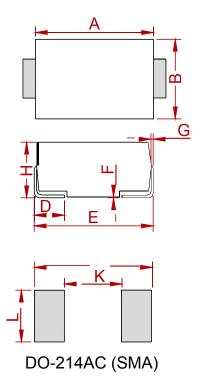




Normalized DC Holding Current vs. Case Temperature



PACKAGE MECHANICAL DATA



	Dimensions				
Ref.	Millimeters		Inches		
	Min.	Max.	Min.	Max.	
Α	4.25	4.65	0.167	0.183	
В	2.50	2.90	0.098	0.114	
С	1.35	1.65	0.053	0.065	
D	0.76	1.52	0.030	0.060	
Е	4.93	5.28	0.194	0.208	
F	0.051	0.203	0.002	0.008	
G	0.15	0.31	0.006	0.012	
Н	1.98	2.41	0.078	0.095	
J	6.50		0.256		
K		2.30		0.090	
L	1.70		0.067		

REEL SPECIFICATION

P/N	PKG	QTY
P0080TA-MS	SMA	7500



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